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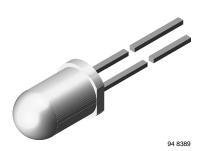


GREEN



Vishay Semiconductors

Infrared Emitting Diode, 875 nm, GaAlAs



DESCRIPTION

The TSHA6500 is an infrared, 875 nm emitting diode in GaAlAs technology, molded in a clear, untinted plastic package.

FEATURES

Package type: leaded
Package form: T-1¾

• Dimensions (in mm): Ø 5

• Peak wavelength: λ_p = 875 nm

· High reliability

• Angle of half intensity: $\varphi = \pm 24^{\circ}$

• Low forward voltage

- · Suitable for high pulse current operation
- · Good spectral matching with Si photodetectors
- Compliant to RoHS Directive 200/95/EC and in accordance to WEEE 2002/96/EC

Note

** Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

APPLICATIONS

- Infrared remote control and free air data transmission systems with comfortable radiation angle
- This emitter is dedicated to systems with panes in transmission space between emitter and detector, because of the low absorbtion of 875 nm radiation in glass

| PRODUCT SUMMARY | | | | |
|-----------------|------------------------|---------|---------------------|---------|
| COMPONENT | I _e (mW/sr) | φ (deg) | λ _P (nm) | tr (ns) |
| TSHA6500 | 30 | ± 24 | 875 | 600 |

Note

· Test conditions see table "Basic Characteristics"

| ORDERING INFORMATI | ON | | |
|--------------------|-----------|------------------------------|--------------|
| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM |
| TSHA6500 | Bulk | MOQ: 4000 pcs, 4000 pcs/bulk | T-1¾ |

Note

MOQ: minimum order quantity

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | |
|---|--|-------------------|---------------|------|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | |
| Reverse voltage | | V_R | 5 | V | |
| Forward current | | I _F | 100 | mA | |
| Peak forward current | $t_p/T = 0.5, t_p = 100 \mu s$ | I _{FM} | 200 | mA | |
| Surge forward current | t _p = 100 μs | I _{FSM} | 2.5 | Α | |
| Power dissipation | | P _V | 180 | mW | |
| Junction temperature | | Tj | 100 | °C | |
| Operating temperature range | | T _{amb} | - 40 to + 85 | °C | |
| Storage temperature range | | T _{stg} | - 40 to + 100 | °C | |
| Soldering temperature | $t \le 5$ s, 2 mm from case | T _{sd} | 260 | °C | |
| Thermal resistance junction/ambient | J-STD-051, leads 7 mm, soldered on PCB | R _{thJA} | 230 | K/W | |





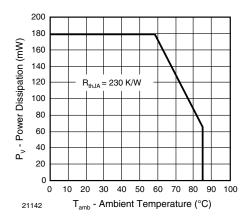


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

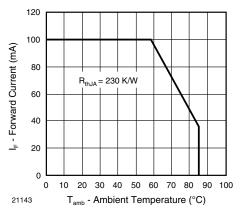


Fig. 1 - Forward Current Limit vs. Ambient Temperature

| BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|---|------------------|------|-------|------|-------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Forward voltage | $I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$ | V _F | | 1.5 | 1.8 | V |
| | $I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$ | V _F | | 2.8 | 3.5 | V |
| Temperature coefficient of V _F | I _F = 100 mA | TK _{VF} | | - 1.6 | | mV/K |
| Reverse current | V _R = 5 V | I _R | | | 100 | μΑ |
| Junction capacitance | $V_R = 0 \text{ V, } f = 1 \text{ MHz, } E = 0$ | Cj | | 20 | | pF |
| B. F | $I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$ | l _e | 16 | 30 | 48 | mW/sr |
| Radiant intensity | $I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$ | l _e | 128 | 240 | | mW/sr |
| Radiant power | $I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$ | фе | | 24 | | mW |
| Temperature coefficient of φ _e | I _F = 20 mA | TKφ _e | | - 0.7 | | %/K |
| Angle of half intensity | | φ | | ± 24 | | deg |
| Peak wavelength | I _F = 100 mA | λ_{p} | | 875 | | nm |
| Spectral bandwidth | I _F = 100 mA | Δλ | | 80 | | nm |
| Temperature coefficient of λ_p | I _F = 100 mA | TKλ _p | | 0.2 | | nm/K |
| Rise time | I _F = 100 mA | t _r | | 600 | | ns |
| | I _F = 1 A | t _r | | 300 | | ns |
| Fall time | I _F = 100 mA | t _f | | 600 | | ns |
| | I _F = 1 A | t _f | | 300 | | ns |
| Virtual source diameter | | d | | 2.2 | | mm |



BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

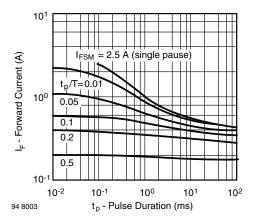


Fig. 2 - Pulse Forward Current vs. Pulse Duration

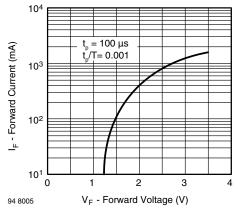


Fig. 3 - Forward Current vs. Forward Voltage

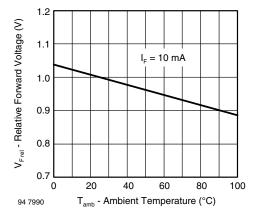


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

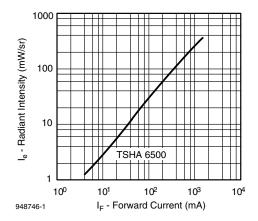


Fig. 5 - Radiant Intensity vs. Forward Current

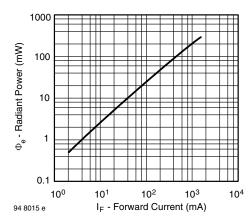


Fig. 6 - Radiant Power vs. Forward Current

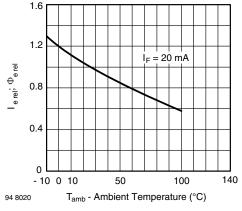


Fig. 7 - Relative Radiant Intensity/Power vs. Ambient Temperature



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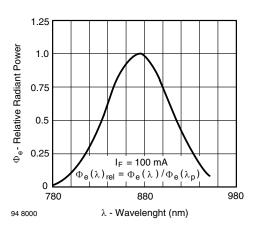


Fig. 8 - Relative Radiant Power vs. Wavelength

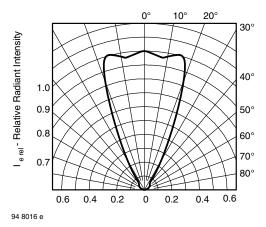
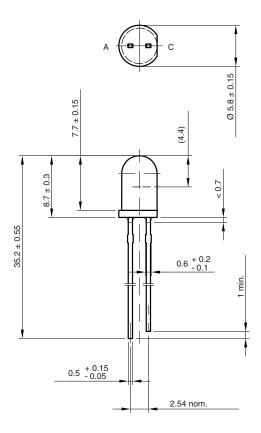
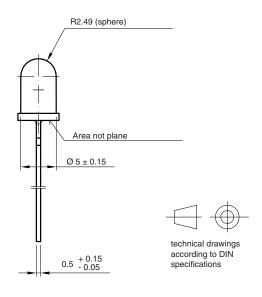


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

PACKAGE DIMENSIONS in millimeters



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